



VARIOUS FEATURES

Features Auto Function, Enhanced Binning, Sequencer Mode, and CCM.



Contrast Mode



ISP ALGORITHMS

Adopts algorithms to enhance image performance.

Hue & Saturation Adjustment

STRUCTURE OPTIMIZATION

Enhanced the dust-proof performance and redesigned the structure.



Color Correction Matrix (CCM)

Adopts CCM to correct the color offset triggered by white balance, and adjusts RGB channels in a non-linear way to make the color of images more vivid.

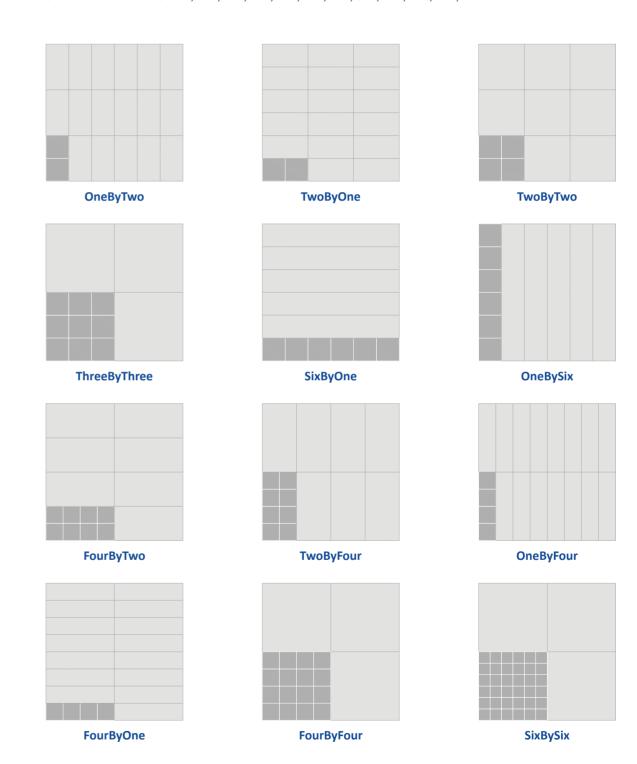


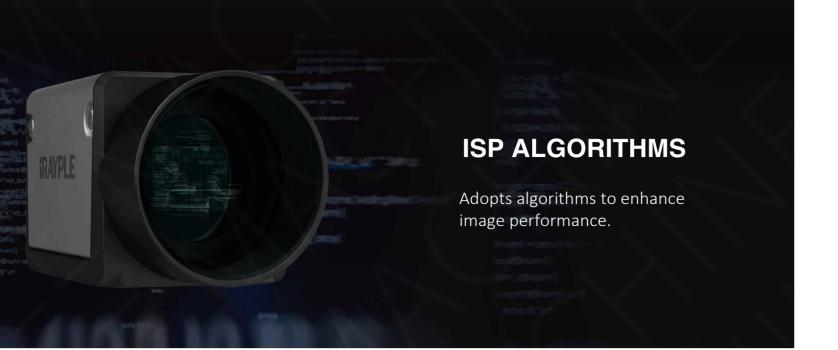


Before

Enhanced Binning

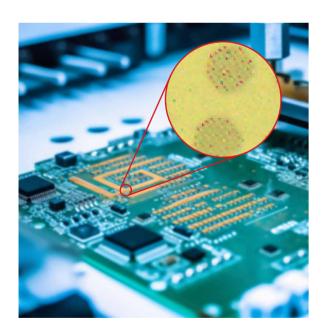
Binning can increase image brightness and signal-to-noise ratio to greatly improve the quality of images. There are up to 12 combinations available: 1×2 , 2×1 , 2×2 , 1×4 , 4×1 , 2×4 , 4×2 , 3×3 , 4×4 , 6×6 , 1×6 , 6×1 .

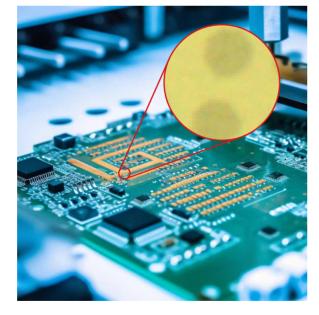




Denoising

Filters out noise without affecting the quality of the image and migrates the processing of noise to reduce CPU usage.



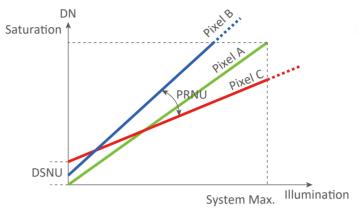


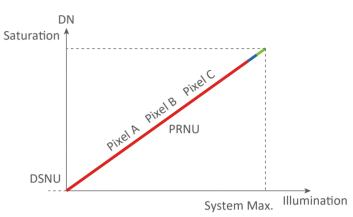
After

Before

FFC (Flat-Field Correction)

Adopts FFC to help ensure that images are uniform. For the image sensor, the camera eliminates the differences in color output that arise during pixel response.

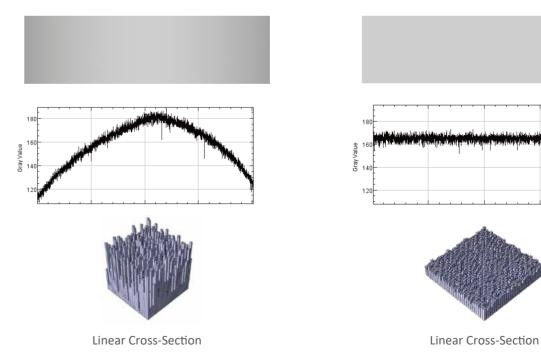




Pixel response curves are inconsistent under the same lighting => Negative impact on FPD detection

Consistent pixel response values under the same lighting => Suitable for FPD detection

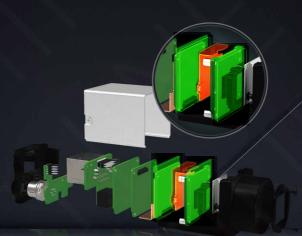
Pixel Consistency Correction



Before After

STRUCTURE OPTIMIZATION

Enhanced the dust-proof performance and redesigned the structure.



APPLICATION SCENES

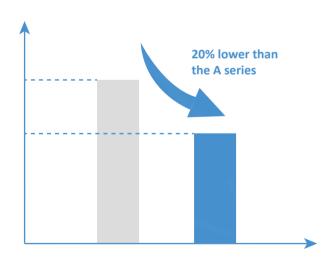
With the rapid development of intelligent manufacturing and the need to improve efficiency and quality control, the Industrial Camera has stepped in, bringing to focus the industry's need for informatization and reliability. The camera not only performs outstandingly, but is also highly reliable and durable. It can be used in multiple, complex industrial scenes and is widely used in the EV battery, 3C, semiconductor, and pharmaceutical industries.



Inspection in the 3C Industry

Low Power Consumption

Upgraded the core hardware, restructured algorithms and reduced power consumption by more than 20% as compared to previous models.



Low power consumption design

Low power comsumption FPGA

Optimized hardware design including power circuit

Optimizaed software

Stucture upgrade



Inspection in the 3C Industry

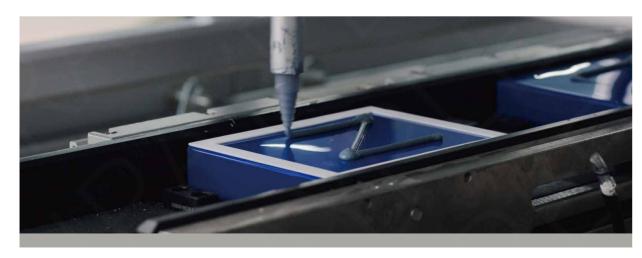
APPLICATION SCENES



Inspection in the Semiconductor Industry



Inspection in the Food and Beverage Industry

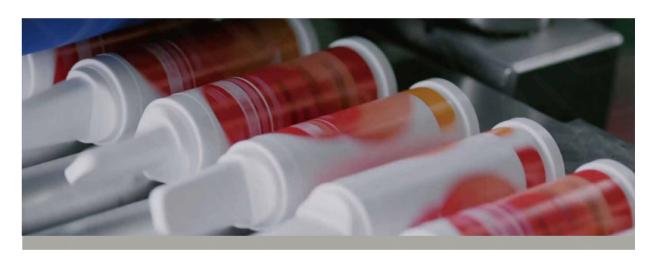


Inspection in the EV Battery Industry

APPLICATION SCENES



Inspection in the EV Battery Industry



Inspection in the Pharmaceutical Industry



Inspection in the Pharmaceutical Industry

Specifications

AE Series						
	AE3138M/CG010E	AE5137M/CG010E	AE5200M/CG010E	AE5207M/CG010E	AE7500M/CG010E	
			Basic			
Sensor	SS	_	IMX430	_	IMX264	
Image Sensor	1/2.7"CMOS	1/1.7"CMOS	1/1.7"CMOS	1/1.7"CMOS	2/3"CMOS	
Shutter	Global	Global	Global	Global	Global	
Resolution	1280 × 1024	1280 × 1024	1624 × 1240	2048 × 1200	2448 × 2048	
Frame Rate	92 fps	90 fps	60 fps	48 fps	24 fps	
Bit Depth	10	12	10	12	12	
Mono/Color	Mono/Color	Mono/Color	Mono/Color	Mono/Color	Mono/Color	
Pixel Size	4.0 μm × 4.0 μm	4.0 μm × 4.0 μm	4.5 μm × 4.5 μm	4.0 μm × 4.0 μm	3.45 μm × 3.45 μm	
		·	Image	1		
Pixel	1.3 MP	1.3MP	2.0 MP	2.0MP	5.0 MP	
S/N Ratio	38 dB	40dB	38 dB	40dB	38 dB	
Dynamic Range	60 dB	66dB	60 dB	66dB	60 dB	
Binning	Support					
ROI	Support					
X Flip	Support					
Y Flip	Support					
Gain	1~32					
Gamma	From 0 to 4, support LUT					
Exposure Time	16 μs~1 s 5 μs~1 s 1 μs~1 s 5 μs~1 s 1 μs~1 s					
Trigger Mode	Software Trigger/Hardware Trigger/Free Run Mode					
SPC	Support					
			Performance			
User Setting	Support two sets of user-defined configurations					
Image Buffer	256MB					
			Port			
Interface	GigE, POE					
GPIO Interface	1× 6 pin Hirose: 1× Opto-isolated input, 1× Opto-isolated output, 1 configurable input and output					
Lens Mount	C-mount					
			Power			
Power Supply	PoE/ DC 9V~24V power supply via Hirose interface					
			Structure			
Product Dimensions	29 mm × 29 mm × 42.5 mm (not including lens mount and rear case connector)					
Net Weight	98 g	98 g	98 g	98 g	98 g	
			Environment			
Storage Temperature	-30°C~+80°C					
Operating Temperature	0°C~+50°C					

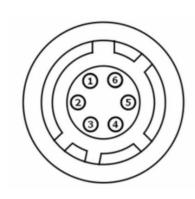
Specifications

		AE S	Series			
	AE3504M/CG010E	AE7501M/CG010E	AE3600M/CG010E	AE3A20M/CG010E	AE3B00M/CG010	
			Basic			
Sensor	AR0521	XGS5000	IMX178	IMX226	IMX183	
Image Sensor	1/2.5"CMOS	2/3"CMOS	1/1.8"CMOS	1/1.7"CMOS	1"CMOS	
Shutter	Rolling	Global	Rolling	Rolling	Rolling	
Resolution	2592 × 1944	2592 × 2048	3072 × 2048	4000 × 3000	5472 × 3648	
Frame Rate	23 fps	22 fps	19 fps	10 fps	6 fps	
Bit Depth	12	12	12	12	12	
Mono/Color	Mono/Color	Mono/Color	Mono/Color	Mono/Color	Mono/Color	
Pixel Size	2.2 μm × 2.2 μm	3.2 μm × 3.2 μm	2.4 μm × 2.4 μm	1.85 μm × 1.85 μm	2.4 μm × 2.4 μ	
			Image			
Pixel	5.0 MP	5.0 MP	6.0 MP	12.0 MP	20.0 MP	
S/N Ratio	>38dB	38 dB	>38dB	38 dB	38 dB	
Dynamic Range	66 dB	60 dB	66 dB	60 dB	60 dB	
Binning	Support					
ROI	Support					
X Flip	Support					
Y Flip	Support					
Gain	1~32					
Gamma	From 0 to 4, support LUT					
Exposure Time	16 μs~1 s 20 μs~1 s 25 μs~1 s 16 μs~1 s 16 μs~1 s					
Trigger Mode		Software Tri	gger/Hardware Trigger/F	ree Run Mode	I	
SPC	Support					
			Performance			
User Setting		Support tw	vo sets of user-defined co	nfigurations		
Image Buffer			256MB			
			Port			
Interface	GigE, PoE					
GPIO Interface	1× 6 pin Hirose: 1× Opto-isolated input, 1× Opto-isolated output, 1 configurable input and output					
Lens Mount	C-mount					
			Power			
Power Supply	PoE/ DC 9V~24V power supply via Hirose interface					
			Structure			
Product Dimensions	2	9 mm × 29 mm × 42.5 mr	n (not including lens mou	nt and rear case connecto	r)	
Net Weight	98 g	98 g	98 g	98 g	98 g	
-	-	_	Environment		_	
torage Temperature			-30°C~+80°C			
perating Temperature						

✓ Connector Pin-out

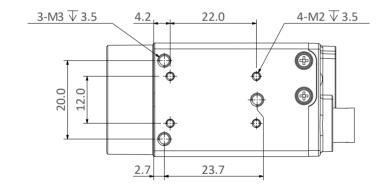
Area scan cameras use the 6-pin cable

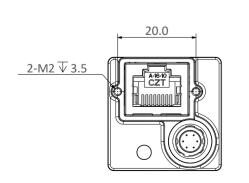
Definitions of camera 6-pin ports				
Color	Pin	Description	Features	
Blue	1	_	+9VDC to 24VDC power supply	
Red	2	Line1	Opto-isolated input	
Gray	3	Line2	GPIO (I/O can be configured for non-isolated software)	
Black	4	Line0	Opto-isolated output	
Green	5	_	Opto-isolated signal ground(ISO_GND)	
Brown	6	_	Camera DC power ground and GPIO signal ground(GND)	

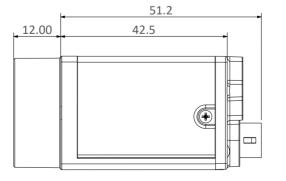


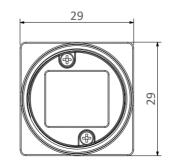
Definition of 6-pin power port

Dimensions









System Components

Compatible Device Models



AE3138M/CG010E,AE5137M/CG010E,AE5200M/CG010E,AE5207M/CG010E,AE3504M/CG010E,AE7500M/CG010E AE7501M/CG010E,AE3600M/CG010E,AE3A20M/CG010E,AE3B00M/CG010E

Cables

Р	Cable	7	Ethernet Cable			
Static		Flexible	Sta	tic	Flexible	
C02-IO-6PIN-DC-	5M-LC C	02-IO-6PIN-DC-FC-10M	C01-GE-RJ4	5-RJ45-7M	C03-GE-RJ45-RJ45-FC-5M	
C02-IO-6PIN-DC-10M-LC		02-IO-6PIN-DC-FC-15M	C01-GE-RJ45	5-RJ45-15M	C03-GE-RJ45-RJ45-FC-10N	
					Q	
12~24 VDC	I/O Signal		PLC Protocols	Ethe	rnet Ethernet	
Power Supply		Host (PLC)		Host (P	C) Set Up (PC)	
12~24 VDC	HMI	PLC PLC Data Center	Factory	PC	PC Debugging Monitoring SDK EDS files Image Saving	